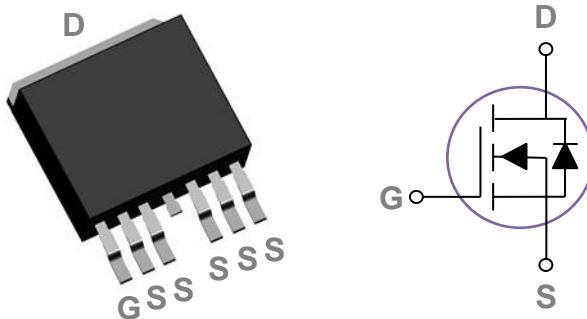


General Description

These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

TO263-6L Pin Configuration



BVDSS	RDS(ON)	ID
100V	2.1mΩ	230A

Features

- 100V,230A, RDS(ON) =2.1mΩ @VGS = 10V
- Improved dv/dt capability
- Fast switching
- 100% EAS Guaranteed
- Green Device Available

Applications

- Networking
- Load Switch
- LED applications
- Quick Charger

Absolute Maximum Ratings $T_c=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	100	V
V_{GS}	Gate-Source Voltage	± 20	V
I_D	Drain Current – Continuous ($T_c=25^\circ\text{C}$)	230	A
	Drain Current – Continuous ($T_c=100^\circ\text{C}$)	147	A
I_{DM}	Drain Current – Pulsed ¹	920	A
EAS	Single Pulse Avalanche Energy ²	952	mJ
IAS	Single Pulse Avalanche Current ²	138	A
P_D	Power Dissipation ($T_c=25^\circ\text{C}$)	298	W
	Power Dissipation – Derate above 25°C	2.38	W/°C
T_{STG}	Storage Temperature Range	-55 to 150	°C
T_J	Operating Junction Temperature Range	-55 to 150	°C

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction to ambient	---	62	°C/W
$R_{\theta JC}$	Thermal Resistance Junction to Case	---	0.42	°C/W



100V N-Channel MOSFETs

PDH00D8BH-S

Electrical Characteristics (T_J=25 °C, unless otherwise noted)**Off Characteristics**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250uA	100	---	---	V
I _{DSS}	Drain-Source Leakage Current	V _{DS} =80V, V _{GS} =0V, T _J =25°C	---	---	1	uA
		V _{DS} =80V, V _{GS} =0V, T _J =85°C	---	---	10	uA
I _{GSS}	Gate-Source Leakage Current	V _{GS} =±20V, V _{DS} =0V	---	---	±100	nA

On Characteristics

R _{DS(ON)}	Static Drain-Source On-Resistance ³	V _{GS} =10V, I _D =20A	---	1.75	2.1	mΩ
V _{GS(th)}	Gate Threshold Voltage	V _{GS} =V _{DS} , I _D =250uA	2	2.6	4	V
g _f s	Forward Transconductance	V _{DS} =10V, I _D =3A	---	21	---	S

Dynamic and switching Characteristics

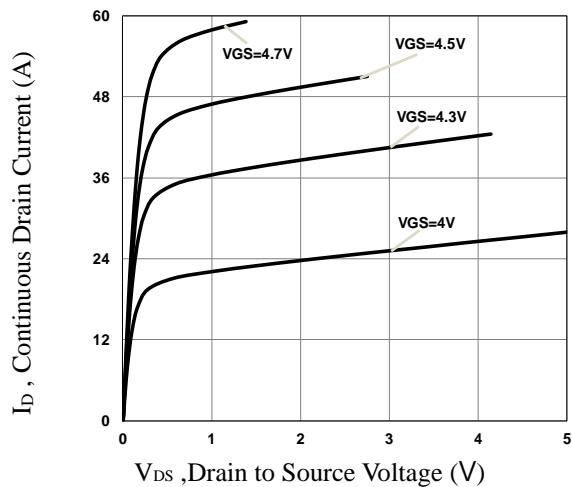
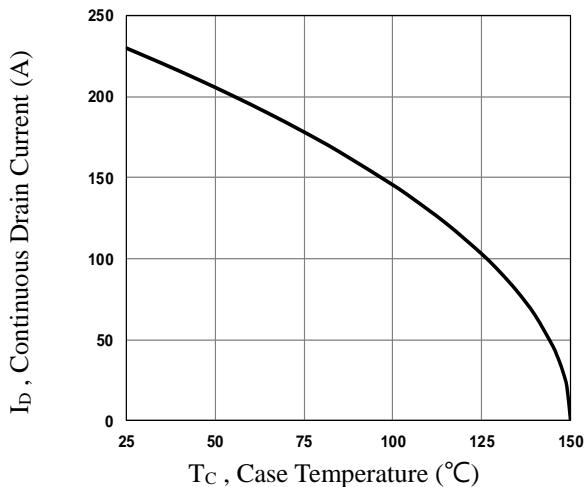
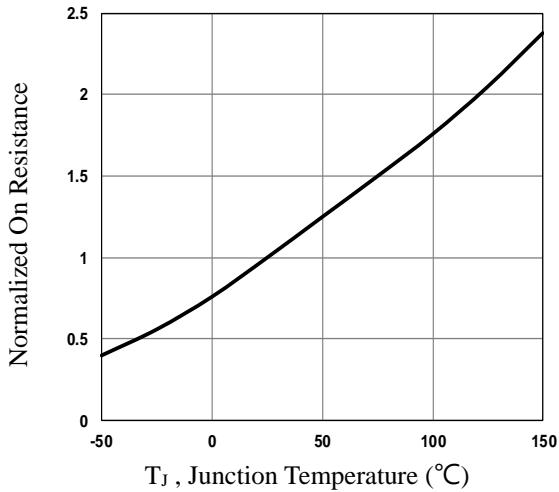
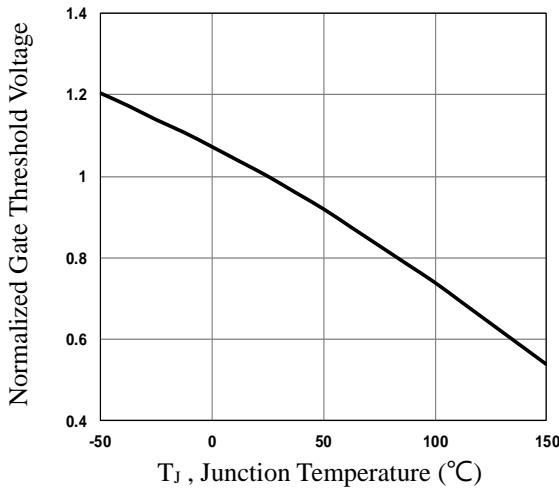
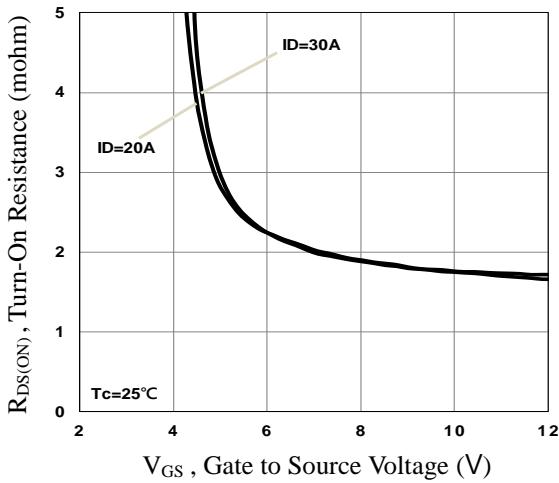
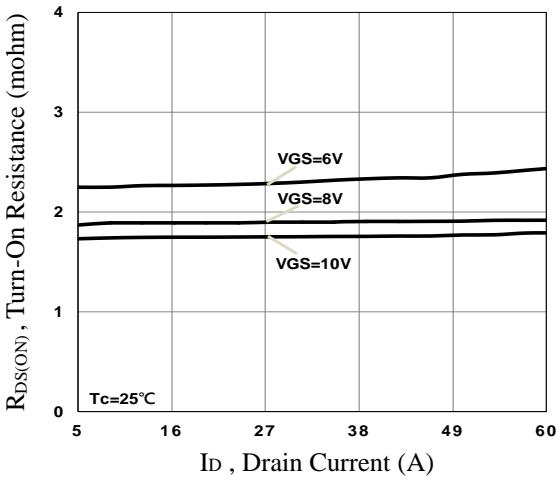
Q _g	Total Gate Charge ^{3, 4}	V _{DS} =50V, V _{GS} =10V, I _D =80A	---	122	185	nC
Q _{gs}	Gate-Source Charge ^{3, 4}		---	27	40	
Q _{gd}	Gate-Drain Charge ^{3, 4}		---	33	50	
T _{d(on)}	Turn-On Delay Time ^{3, 4}	V _{DD} =50V, V _{GS} =10V, R _G =6Ω I _D =80A	---	20	30	ns
T _r	Rise Time ^{3, 4}		---	32	50	
T _{d(off)}	Turn-Off Delay Time ^{3, 4}		---	98	150	
T _f	Fall Time ^{3, 4}		---	32	50	
C _{iss}	Input Capacitance	V _{DS} =50V, V _{GS} =0V, F=1MHz	---	7700	11550	pF
C _{oss}	Output Capacitance		---	1500	2250	
C _{rss}	Reverse Transfer Capacitance		---	30	45	
R _g	Gate resistance	V _{GS} =0V, V _{DS} =0V, F=1MHz	---	1	---	Ω

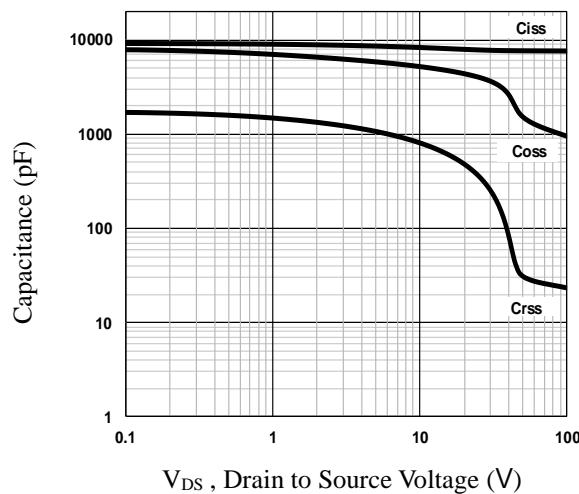
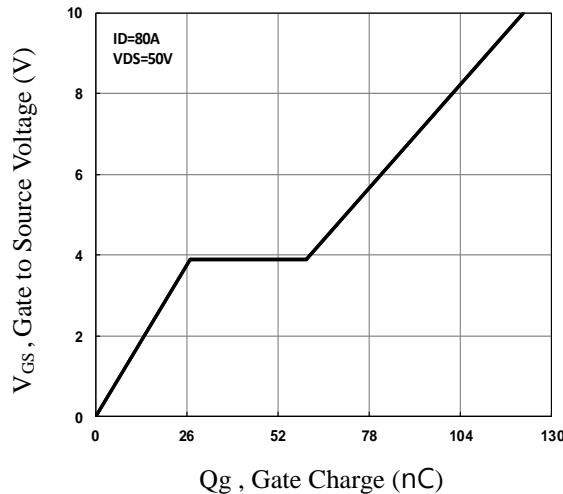
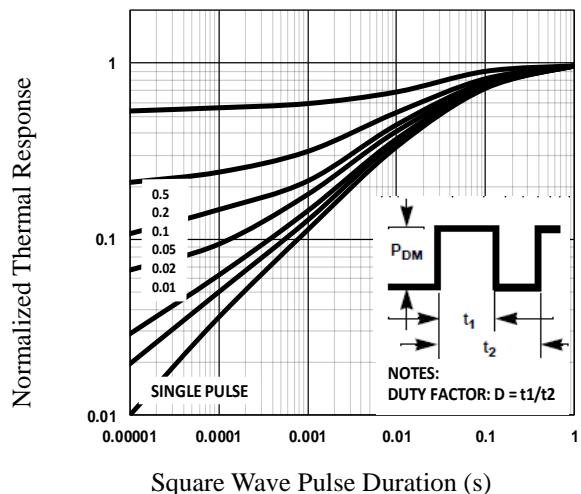
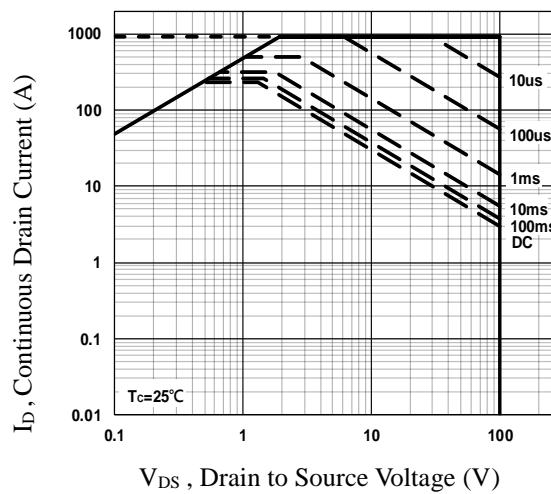
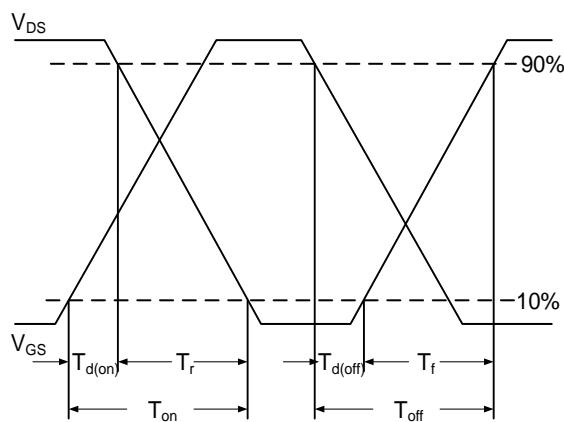
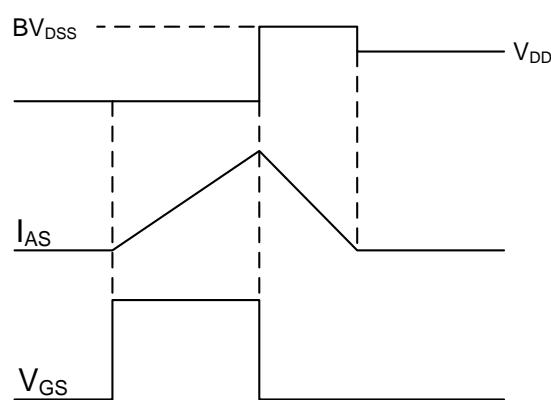
Drain-Source Diode Characteristics and Maximum Ratings

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I _s	Continuous Source Current	V _G =V _D =0V, Force Current	---	---	230	A
I _{SM}	Pulsed Source Current		---	---	460	A
V _{SD}	Diode Forward Voltage	V _{GS} =0V, I _s =1A, T _J =25°C	---	---	1	V
t _{rr}	Reverse Recovery Time	V _R =100V, I _s =10A di/dt=100A/μs, T _J =25°C	---	250	---	ns
Q _{rr}	Reverse Recovery Charge		---	820	---	nC

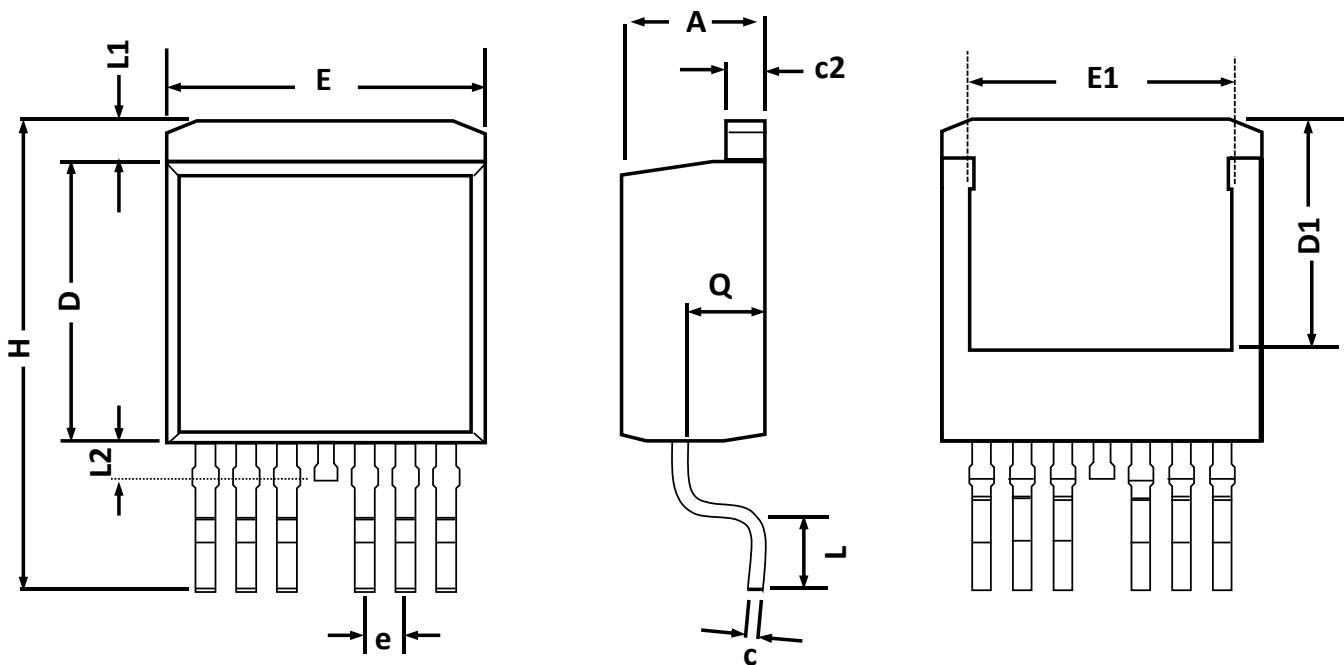
Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2. V_{DD}=50V, V_{GS}=10V, L=0.1mH, I_{AS}=138A., R_G=25Ω, Starting T_J=25°C.
3. The data tested by pulsed, pulse width ≤ 300us, duty cycle ≤ 2%.
4. Essentially independent of operating temperature.


Fig.1 Typical Output Characteristics

Fig.2 Continuous Drain Current vs. T_c

Fig.3 Normalized $R_{DS(on)}$ vs. T_J

Fig.4 Normalized V_{th} vs. T_J

Fig.5 Turn-On Resistance vs. V_{GS}

Fig.6 Turn-On Resistance vs. I_D

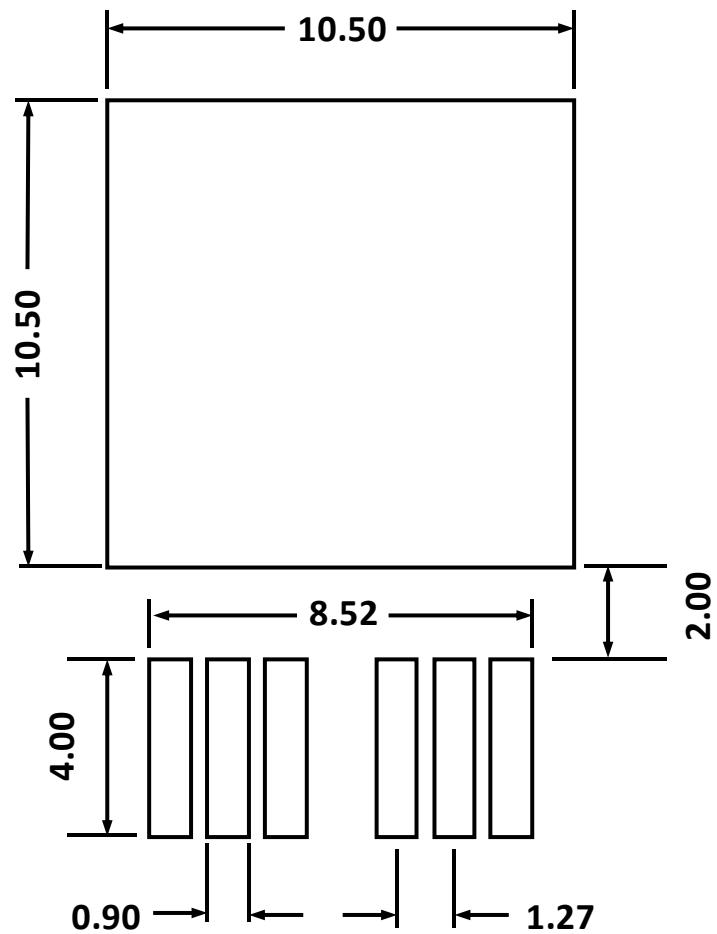

Fig.7 Capacitance Characteristics

Fig.8 Gate Charge Characteristics

Fig.9 Normalized Transient Impedance

Fig.10 Maximum Safe Operation Area

Fig.11 Switching Time Waveform

Fig.12 EAS Waveform

TO263-6L PACKAGE INFORMATION



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Max	Min	Max	Min
A	4.650	4.200	0.183	0.165
b	0.700	0.500	0.028	0.020
c	0.600	0.400	0.024	0.016
c2	1.400	1.150	0.055	0.045
D	9.050	8.800	0.356	0.346
D1	---	6.850	---	0.270
E	10.400	9.950	0.409	0.392
E1	8.550	8.150	0.337	0.321
e	1.270 BSC		0.050 BSC	
H	15.900	14.600	0.626	0.575
L	2.800	1.750	0.110	0.069
L1	1.360 REF.		0.054 REF.	
L2	1.200 REF.		0.047 REF.	
Q	2.700	2.300	0.106	0.091

TO263-6L RECOMMENDED LAND PATTERN



unit : mm